

Single Channel

Silicon ESD Protector Overvoltage Protection Device PRODUCT: SESD0402X1BN-0010-098

DOCUMENT: SCD28187 **REV LETTER: A**

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Specification Status: Preliminary

BENEFITS

- Industry-leading lowest capacitance; provides lowest insertion loss for high speed data signals
- Small size ESD protection diodes for high speed data signals (0402 size devices)
- Helps protect electronic circuits against damage from Electrostatic Discharge (ESD), surge and cable discharge events
- Assists equipment to pass IEC61000-4-2, level 4 testing

FEATURES

- Low capacitance: 0.10 pF (typ, bi-di)
- Low leakage current: 50nA @ 5V (max)
- Low clamping voltage: ±9.90V (typ, bi-di) @ (tp=8x20µs, Ipp=2A)
- ESD maximum rating per IEC61000-4-2 standard:
 - ± 20kV contact discharge
 - ± 20kV air discharge
- Surge: 2A (max, bi-di) @ (tp=8x20µs) per IEC61000-4-2-5
- Small size and low profile: XDFN packages
- Bi-directional operation

APPLICATIONS

- Consumer, mobile and portable electronics
- Tablet PC and external storage with high speed interfaces
- Ultra-high speed data lines
- USB 3.0/2.0, HDMI 1.3/1.4, DisplayPort, Thunderbolt (Light Peak), V-by-One HS, and LVDS interfaces
- Applications requiring high ESD performance in small packages

MATERIALS INFORMATION

RoHS Compliant

ELV Compliant Halogen Free * Lead Free





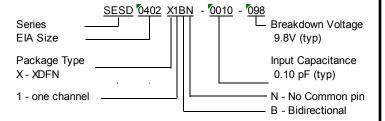




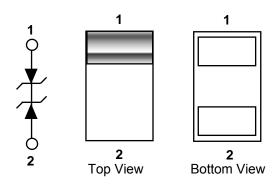
* Halogen Free refers to: Br≤900ppm, Cl≤900ppm, Br+Cl≤1500ppm SESD devices meet MSL-1 Requirements DFN case epoxy meets UL 94 V-0



PART NUMBERING



SCHEMATIC AND PIN CONFIGURATION





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DEVICE MAXIMUM RATING

ESD Withstand ⁽¹⁾ (IEC 61000-4-2, level 4)		Temperature		Peak Current (tp=8x20μs)
Contact (kV)	Air (kV)	Operating (°C)	Storage (°C)	lpp (A)
± 20	± 20	-55 to +125	-55 to +150	2.0

^{(1) 20}kV @ ± 1 pulse; 10kV @ ± 50 pulses; 8kV @ 1,000 pulses (under IEC6100-4-2)

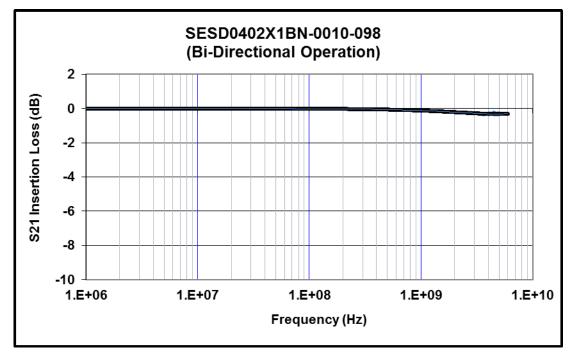
- Device maximum rating @ T = 25°C, unless otherwise specified
- Caution: Stress exceeding Device Maximum Ratings may damage the device
 Prolonged exposure to stresses above the recommended operating conditions may affect device reliability

DEVICE ELECTRICAL CHARACTERISTICS

Input Capacitance		Breakdown Voltage	Reverse Working		Reverse Leakage Current		Clamping Voltage
@ $V_R = 0V$, $f = 3GHz$ (pF)		V _{BR} @ I _T =1mA (V)	@ I _T =1mA (V) Voltage (V)		I _L @ V _{WRV} =5.0V (nA)		V _{CL} @ lpp=2.0A (V)
Тур	Maximum	Тур	Min	Max	Тур	Max	Max
0.10	0.12	+9.80 / -9.80	-9.00	+9.00	<5.0	50.0	+9.90 / -9.90

[•] All device electrical characteristics @ T = 25°C, unless otherwise specified

FIGURE 1. INSERTION LOSS DIAGRAM



Application	Bit Rate (Gbps)	@Freq (GHz)	Ins. Loss (dB)
HDMI 1.4 (1080P)	2.25	1.13	-0.12
DisplayPort	2.70	1.35	-0.16
HDMI 1.4 (max spec)	3.40	1.70	-0.19
USB3.0	5.00	2.50	-0.23
eSATA	6.00	3.00	-0.27
Thunderbolt	10.0	5.00	-0.30



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FIGURE 2. DEVICE IV CURVE

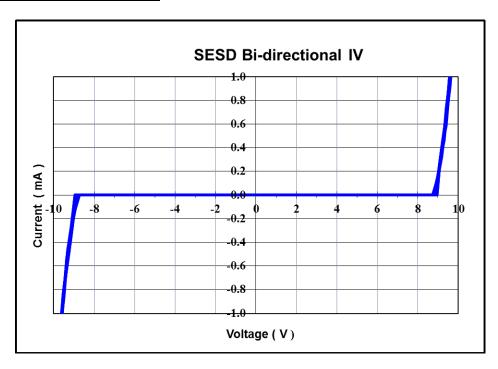
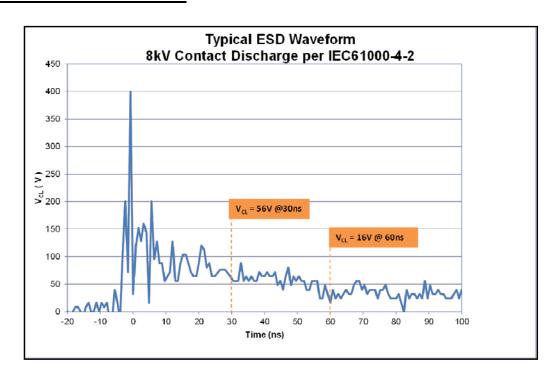


FIGURE 4. ESD WITHSTAND





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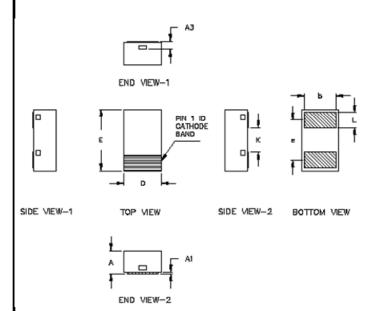
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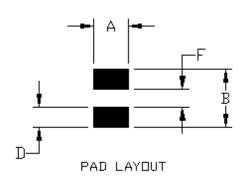
DEVICE DIMENSIONS



	SESD0402X1BN-0010-098					
	Miln	neters (r	nm)	Inches (in)		
Dim	Min	Nom	Max	Min	Nom	Max
Α	0.33	0.38	0.43	0.0130	0.0150	0.0170
A1	0	ı	0.05	0	ı	0.0020
A3	(0.130 ref		0.005 ref.		
D	0.550	0.600	0.650	0.0220	0.0240	0.0260
E	0.950	1.000	1.050	0.0370	0.0390	0.0410
K	0.350	0.400	0.450	0.0140	0.0160	0.0180
b	0.450	0.500	0.550	0.0180	0.0200	0.0220
L	0.200	0.250	0.300	0.0080	0.0100	0.0120
е	0.650 BSC			0	.026 BS	С

BSC - Basic Spacing between Centers

RECOMMENDED LANDING PATTERN:



SESD Landing Pad Layout 0402 Package				
Symbol Milimeters Inches (mm) (in)				
Α	0.60	0.024		
В	1.00	0.039		
D	0.35	0.014		
F	0.30	0.012		

PACKAGING

Packaging	Tape & Reel	Standard Box
SESD0402X1BN-0010-098	10,000	50,000



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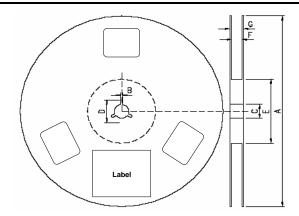
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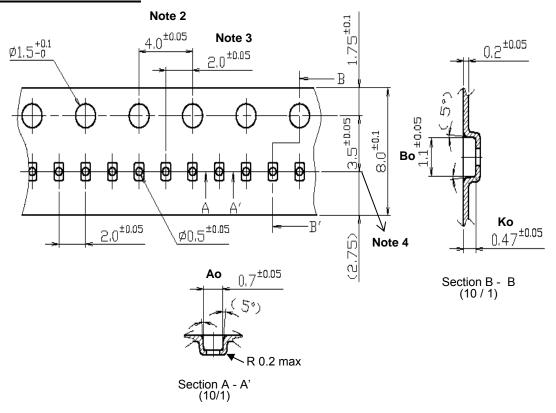
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REEL DIMENSIONS



	Dimensions	А	В	С	D	E	F	G
Ī	(mm)	180.0 ± 1.5	2.3. 0 ± 0.2	13.0 + 0.5 / -0.2	17.3 ± 0.2	60.5 ± 1.5	8.4 +1.5/-0.0	14.4 (max)

CARRIER TAPE DIMENSIONS



Ao	0.07 ± 0.05
Во	1.10 ± 0.05
Ko	0.47 ± 0.05

Note 1. All dimensions in mm

Note 2. Cumulative tolerance is 200 ± 0.3 / 50MM pitch

Note 3. Center point of hole tolerance is 2.0 ± 0.5

Note 4. Center point of hole tolerance is 3.5 ± 0.5



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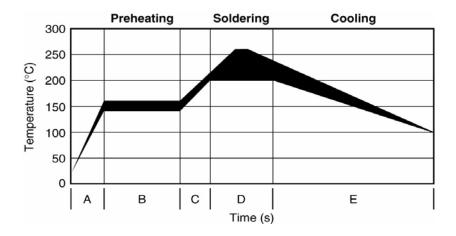
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SOLDER REFLOW RECOMMENDATION

Α	Temperature	From ambient to	30s to 60s	
_ ^	ramp up 1	Preheating temperature	308 10 008	
В	Preheating 140°C - 160°C		60s to 120s	
С	Temperature	From Preheating to Main	20s to 40s	
	ramp up 2	heating temperature	203 10 403	
		at 200°C	60s ~ 70s	
D	Main heating	Main hosting at 220°C	50s ~ 60s	
	Main nealing	at 240°C	30s ~ 40s	
		at 260°C	5s ~ 10s	
Е	Cooling	From main heating	4°C/s (max)	
_	Cooling	temperature to 100°C	4 C/S (IIIax)	

FIGURE 4. REFLOW PROFILE



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